



Size:
1.91 x 1.09 x 0.37 in
48,6 x 27,7 x 9,5 mm

Applications

- High Voltage 270V Aircraft Distributed Power
- 28Vdc MIL-COTS PRM Interface (MPO28F036M21AL)
- Communications Systems
- High Density Power Supplies

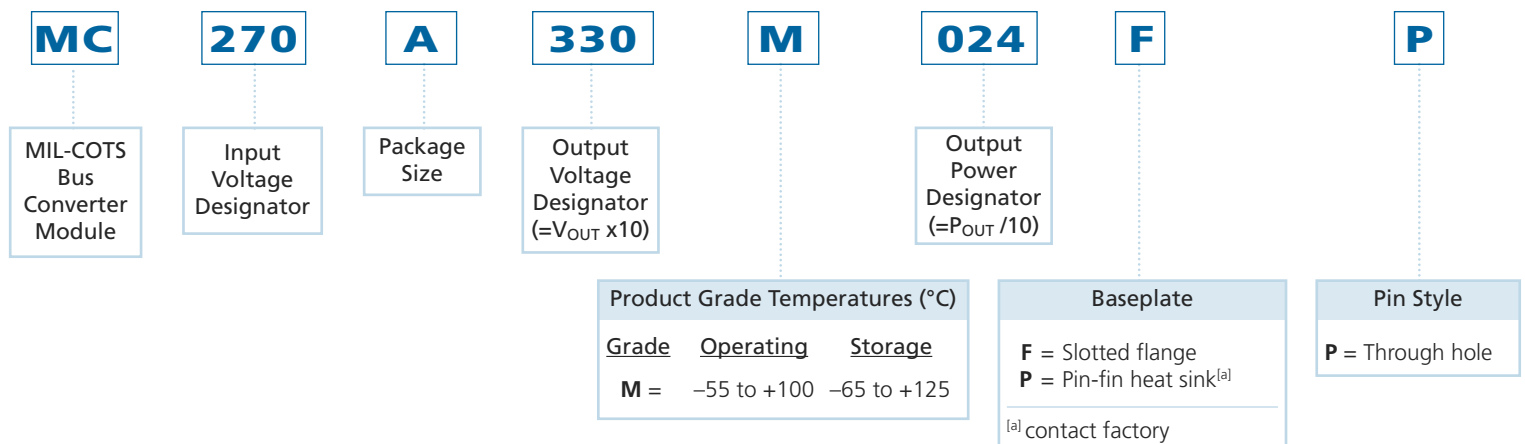
Features

- 100°C baseplate operation
- 270 V to 33.75 V Bus Converter
- 235 Watt (360 Watt for <5 ms)
- MIL-STD-704E/F compliant
- High density – up to 312 W/in³
- Small footprint – 1.64 and 2.08 in²
- Height above board – 0.37 in (9.5 mm)
- Low weight – 1.10 oz (31.3 g)
- ZVS / ZCS isolated Sine Amplitude Converter
- Typical efficiency >95%
- <1 μs transient response
- Isolated output
- No output filtering required

Product Overview

The MIL-COTS VI BRICK BCM module uses advanced Sine Amplitude Converter™ (SAC™) technology, thermally enhanced packaging technologies, and advanced CIM processes to provide high power density and efficiency, superior transient response, and improved thermal management. These modules can be used to provide an isolated intermediate bus to power non-isolated POL converters and due to the fast response time and low noise of the BCM, capacitance can be reduced or eliminated near the load.

Part Numbering



Absolute Maximum Ratings

	Min	Max	Unit
+In to -In	-1.0	+400	Vdc
PC to -In	-0.3	+20	Vdc
TM to -In	-0.3	+7	Vdc
+In/-In to +Out/-Out (hipot)		4242	V
+In/-In to +Out/-Out (working)		500	V
+Out to -Out	-1.0	+60	Vdc

CONTROL PIN SPECIFICATIONS

See page 13 for further application details and guidelines.

PC – VI BRICK BCM Primary Control

The PC pin can enable and disable the BCM. When held below V_{PC_DIS} the BCM shall be disabled. When allowed to float with an impedance to -IN of greater than 50 kΩ the module will start. When connected to another BCM PC pin, the BCMs will start simultaneously when enabled. The PC pin is capable of being driven high by either an external logic signal or internal pull up to 5 V (operating).

TM – VI BRICK BCM Temperature Monitor

The TM pin monitors the internal temperature of the BCM within an accuracy of +5/-5°C. It has a room temperature setpoint of ~3.0 V and an approximate gain of 10 mV/°C. It can source up to 100 μA and may also be used as a “Power Good” flag to verify that the BCM is operating.

Note: If TM is not used to validate the thermal management system, a 100°C case (baseplate) maximum applies.

SPECIFICATIONS (CONT.)

Specifications apply over all line and load conditions unless otherwise noted; **Boldface** specifications apply over the temperature range of $-55^{\circ}\text{C} < T_C < 100^{\circ}\text{C}$ (T-Grade); All other specifications are at $T_C = 25^{\circ}\text{C}$ unless otherwise noted

Electrical Characteristics						
Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Voltage Range	V_{IN}		240	270	330	Vdc
dV/dt	dV_{IN}/dt				1	V/ μs
Quiescent Power	P_Q	PC connected to -IN		395	410	mW
No Load Power Dissipation	P_{NL}	$V_{IN} = 240$ to 330 V			10	W
Inrush Current Peak	I_{INR_P}	$V_{IN} = 330$ V $C_{OUT} = 100$ μF , $P_{OUT} = 235$ W		2.5	4	A
DC Input Current	I_{IN_DC}	$P_{OUT} = 235$ W			0.95	A
K Factor $\left(\frac{V_{OUT}}{V_{IN}}\right)$	K			1/8		
Output Power (Average)	P_{OUT}	$V_{IN} = 270$ V _{DC} ; See Figure 14 $V_{IN} = 240 - 330$ V _{DC} ; See Figure 14			235 215	W
Output Power (Peak)	P_{OUT_P}	$V_{IN} = 270$ V _{DC} Average $P_{OUT} \leq 235$ W, $T_{peak} < 5$ ms			352.5	W
Output Voltage	V_{OUT}	See Page 11; No load	30		41.25	V
Output Current (Average)	I_{OUT}	$P_{OUT} \leq 235$ W			7.3	A
Efficiency (Ambient)	η	$V_{IN} = 270$ V, $P_{OUT} = 235$ W $V_{IN} = 240$ V to 330 V, $P_{OUT} = 235$ W	94.1 94	95.4 95.2		%
Efficiency (Hot)	η	$V_{IN} = 270$ V, $T_J = 100^{\circ}\text{C}$, $P_{OUT} = 235$ W	93.7	94.7		%
Minimum Efficiency (Over Load Range)	η	60 W $< P_{OUT} < 235$ W Max	90			%
Output Resistance (Ambient)	R_{OUT}	$T_J = 25^{\circ}\text{C}$	100	130	170	m Ω
Output Resistance (Hot)	R_{OUT}	$T_J = 125^{\circ}\text{C}$	130	180	210	m Ω
Output Resistance (Cold)	R_{OUT}	$T_J = -55^{\circ}\text{C}$	40	105	160	m Ω
Load Capacitance	C_{OUT}				100	μF
Switching Frequency	F_{SW}		1.56	1.64	1.72	MHz
Ripple Frequency	F_{SW_RP}		3.12	3.28	3.44	MHz
Output Voltage Ripple	V_{OUT_PP}	$C_{OUT} = 0$ μF , $P_{OUT} = 235$ W, $V_{IN} = 270$ V, See Page 15		160	400	mV
V_{IN} to V_{OUT} (Application of V_{IN})	T_{ON1}	$V_{IN} = 270$ V, $C_{PC} = 0$; See Figure 17	460	540	620	ms
PC						
PC Voltage (Operating)	V_{PC}		4.7	5	5.3	V
PC Voltage (Enable)	V_{PC_EN}		2	2.5	3	V
PC Voltage (Disable)	V_{PC_DIS}				1.95	V
PC Source Current (Startup)	I_{PC_EN}		50	100	300	μA
PC Source Current (Operating)	I_{PC_OP}		2	3.5	5	mA
PC Internal Resistance	R_{PC_SNK}	Internal pull down resistor	50	150	400	k Ω
PC Capacitance (Internal)	C_{PC_INT}	See Page 13			1000	pF
PC Capacitance (External)	C_{PC_EXT}	External capacitance delays PC enable time			1000	pF
External PC Resistance	R_{PC}	Connected to $-V_{IN}$	50			k Ω
PC External Toggle Rate	F_{PC_TOG}				1	Hz
PC to V_{OUT} with PC Released	T_{on2}	$V_{IN} = 270$ V, Pre-applied $C_{PC} = 0$, $C_{OUT} = 0$; See Figure 17	50	100	150	μs
PC to V_{OUT} , Disable PC	T_{PC_DIS}	$V_{IN} = 270$ V, Pre-applied $C_{PC} = 0$, $C_{OUT} = 0$; See Figure 17		4	10	μs

SPECIFICATIONS (CONT.)

Specifications apply over all line and load conditions unless otherwise noted; **Boldface** specifications apply over the temperature range of $-55^{\circ}\text{C} < T_C < 100^{\circ}\text{C}$ (**T-Grade**); All other specifications are at $T_C = 25^{\circ}\text{C}$ unless otherwise noted

Electrical Characteristics (Continued)						
Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
TM						
TM accuracy	A_{CTM}		-5		+5	$^{\circ}\text{C}$
TM Gain	A_{TM}			10		$\text{mV}/^{\circ}\text{C}$
TM Source Current	I_{TM}		100			μA
TM Internal Resistance	R_{TM_SNK}		25	40	50	$\text{k}\Omega$
External TM Capacitance	C_{TM}				50	pF
TM Voltage Ripple	V_{TM_PP}	$C_{TM} = 0 \mu\text{F}, V_{IN} = 330 \text{ V}, P_{OUT} = 235 \text{ W}$	200	400	500	mV
PROTECTION						
Negative going OVLO	V_{IN_OVLO-}		350	365	380	V
Positive going OVLO	V_{IN_OVLO+}		355	372	385	V
Negative going UVLO	V_{IN_UVLO-}		90	115	125	V
Positive going UVLO	V_{IN_UVLO+}		100	125	135	V
Output Overcurrent Trip	I_{OCP}	$V_{IN} = 270 \text{ V}, 25^{\circ}\text{C}$	9	12	14	A
Short Circuit Protection Trip Current	I_{SCP}		14			A
Short Circuit Protection Response Time	T_{SCP}		0.8	1	1.2	μs
Thermal Shutdown Junction setpoint	T_{J_OTP}		125	130	135	$^{\circ}\text{C}$
GENERAL SPECIFICATION						
Isolation Voltage (hipot)	V_{HIPOT}		4242			V
Working Voltage (In – Out)	$V_{WORKING}$				500	V
Isolation Capacitance	C_{IN_OUT}	Unpowered unit	500	660	800	pF
Isolation Resistance	R_{IN_OUT}		10			$\text{M}\Omega$
MTBF		MIL HDBK 217F, 25°C , GB		4.2		Mhrs
Agency Approvals/Standards		cTUVus CE Mark				

SPECIFICATIONS (CONT.)

All specifications are at $T_C = 25^\circ\text{C}$ unless otherwise noted. See associated figures for general trend data.

Application Characteristics				
Attribute	Symbol	Conditions / Notes	Typ	Unit
No Load Power	P_{NL}	$V_{IN} = 270\text{ V}$, PC enabled; See Figure 1	5.5	W
Inrush Current Peak	I_{NR_P}	$C_{OUT} = 100\ \mu\text{F}$, $P_{OUT} = 235\text{ W}$	2.5	A
Efficiency (Ambient)	η	$V_{IN} = 270\text{ V}$, $P_{OUT} = 235\text{ W}$	95.4	%
Efficiency (Hot – 100°C)	η	$V_{IN} = 270\text{ V}$, $P_{OUT} = 235\text{ W}$	94.7	%
Output Resistance (-40°C)	R_{OUT}	$V_{IN} = 270\text{ V}$	105	m Ω
Output Resistance (25°C)	R_{OUT}	$V_{IN} = 270\text{ V}$	130	m Ω
Output Resistance (120°C)	R_{OUT}	$V_{IN} = 270\text{ V}$	180	m Ω
Output Voltage Ripple	V_{OUT_PP}	$C_{OUT} = 0\ \mu\text{F}$, $P_{OUT} = 235\text{ W}$ @ $V_{IN} = 270$, $V_{IN} = 270\text{ V}$	160	mV
V_{OUT} Transient (Positive)	V_{OUT_TRAN+}	$I_{OUT_STEP} = 0$ TO 7.3 A, $I_{SLEW} > 10\text{ A/us}$; See Figure 11	1.4	V
V_{OUT} Transient (Negative)	V_{OUT_TRAN-}	$I_{OUT_STEP} = 7.3\text{ A}$ TO 0 A, $I_{SLEW} > 10\text{ A/us}$; See Figure 12	1.3	V
Undervoltage Lockout Response Time	T_{UVLO}		150	us
Output Overcurrent Response Time	T_{OCP}	$9 < I_{OCP} < 14\text{ A}$	5	ms
Overvoltage Lockout Response Time	T_{OVLO}		120	μs
TM Voltage (Ambient)	V_{TM_AMB}	$T_J \cong 27^\circ\text{C}$	3	V

WAVEFORMS

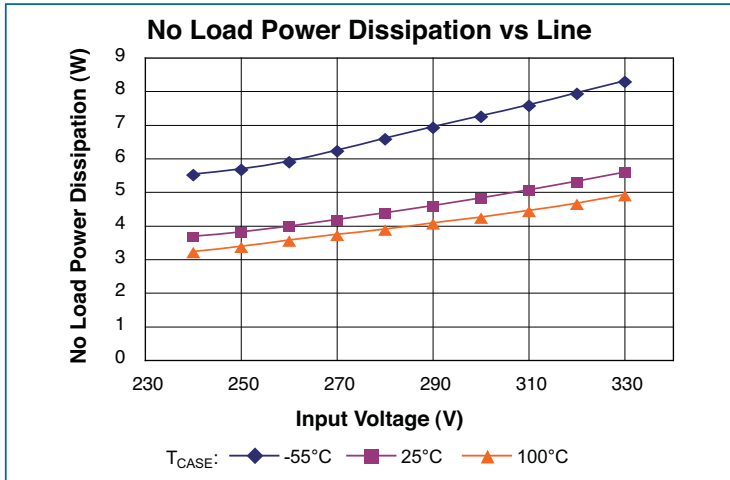


Figure 1 — No load power dissipation vs. V_{IN} ; T_{CASE}

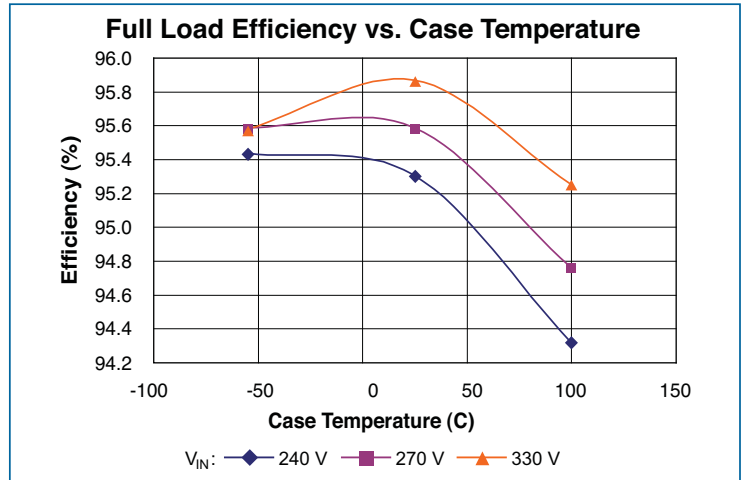


Figure 2 — Full load efficiency vs. temperature; V_{IN}

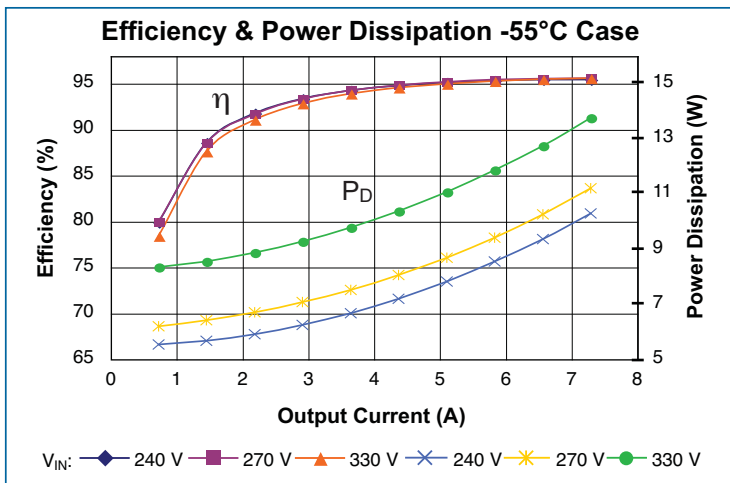


Figure 3 — Efficiency and power dissipation at -55°C (case); V_{IN}

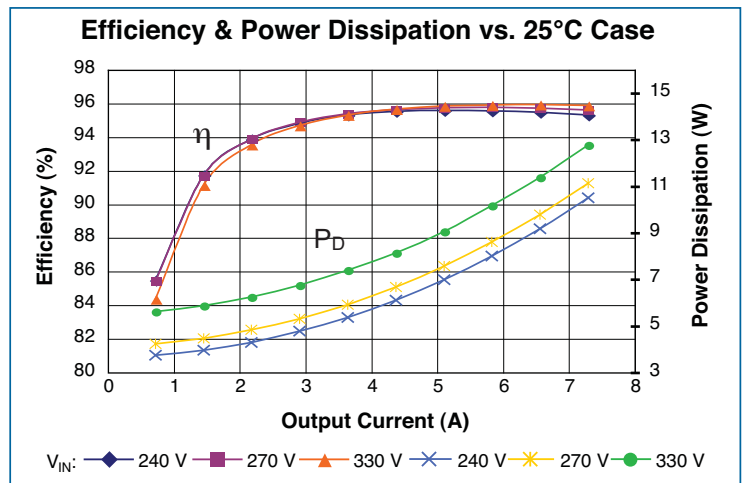


Figure 4 — Efficiency and power dissipation at 25°C (case); V_{IN}

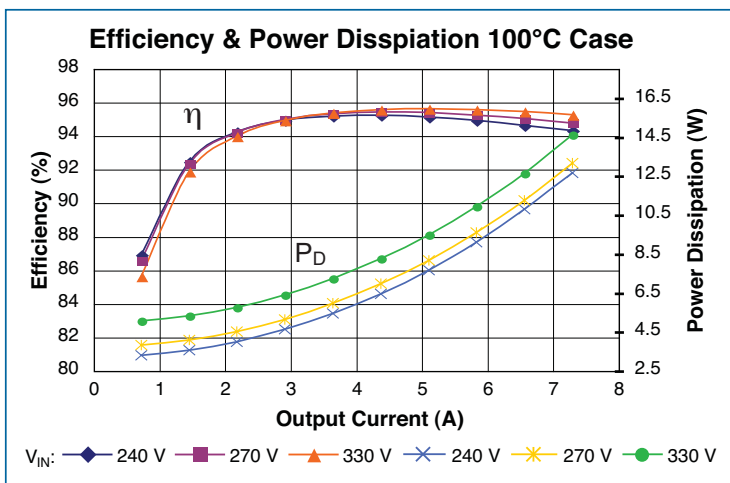


Figure 5 — Efficiency and power dissipation at 100°C (case); V_{IN}

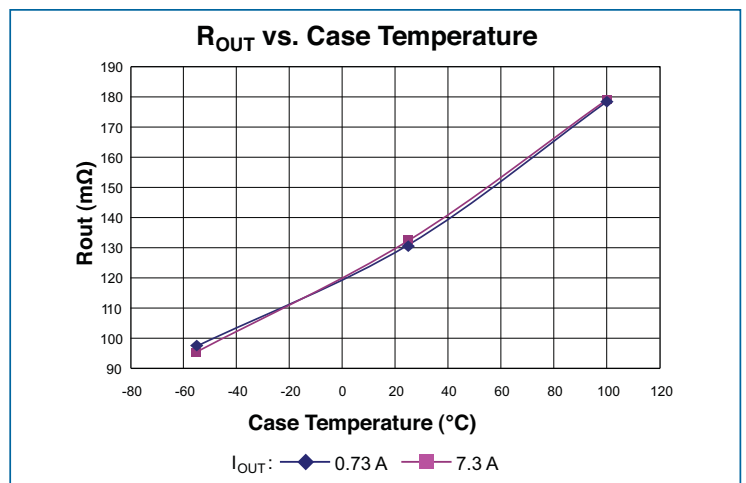


Figure 6 — R_{OUT} vs. temperature vs. I_{OUT}

SPECIFICATIONS (CONT.)

WAVEFORMS (CONT.)

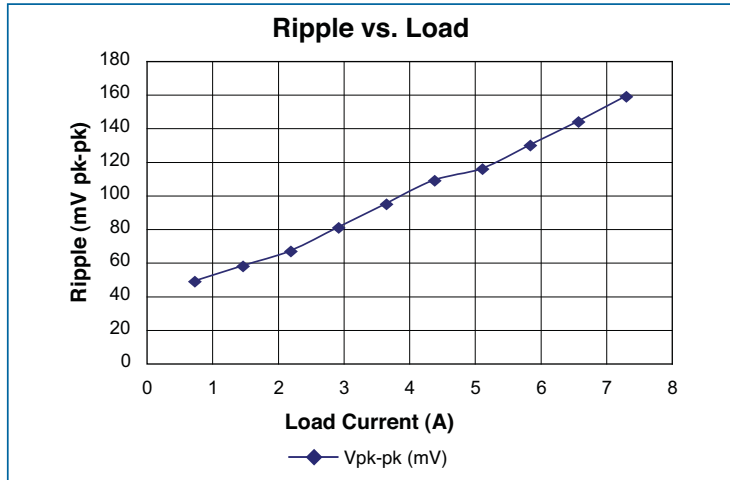


Figure 7 — V_{ripple} vs. I_{OUT} ; 270 V_{in} , no external capacitance

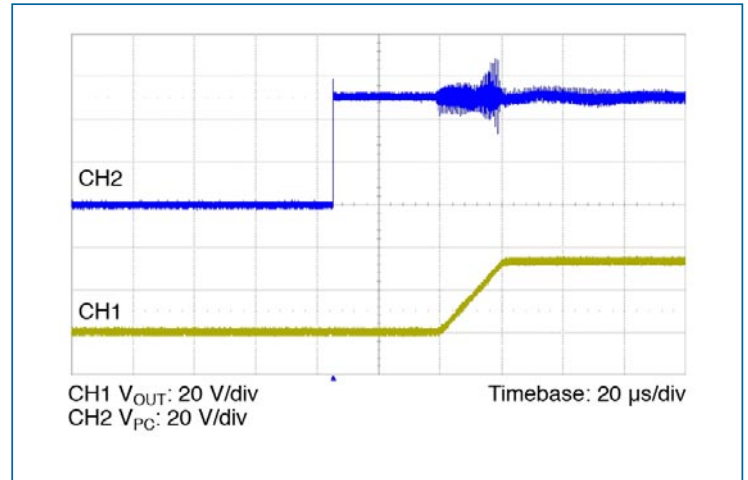


Figure 8 — PC to V_{OUT} startup waveform

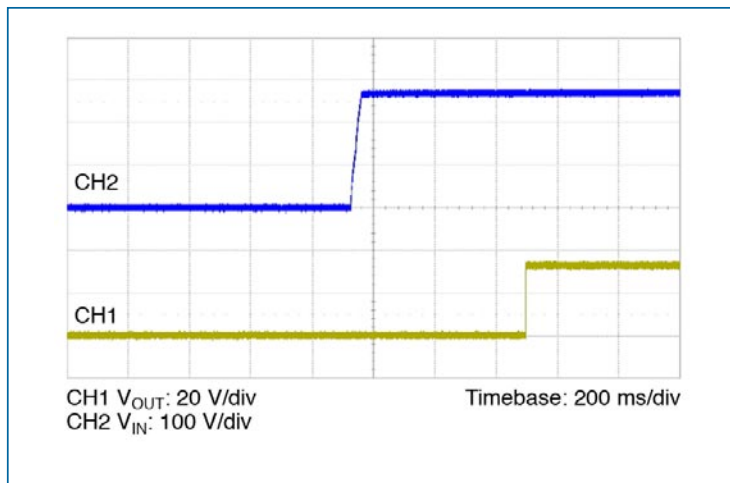


Figure 9 — V_{IN} to V_{OUT} startup waveform

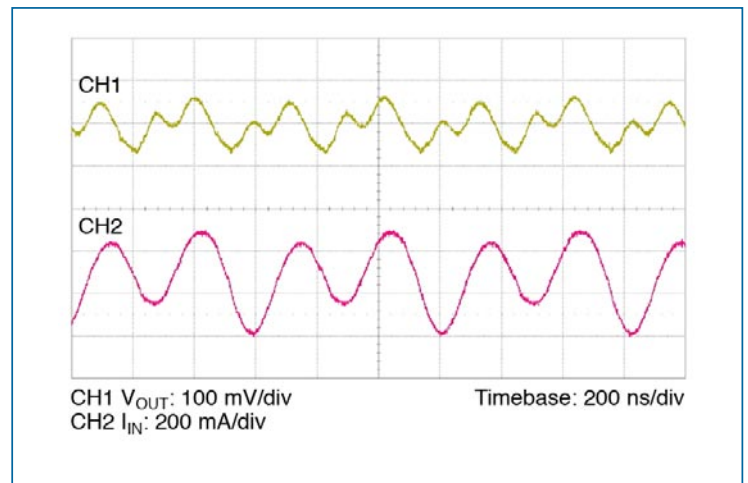


Figure 10 — Output voltage and input current ripple, 270 V_{in} , 235 W no C_{OUT}

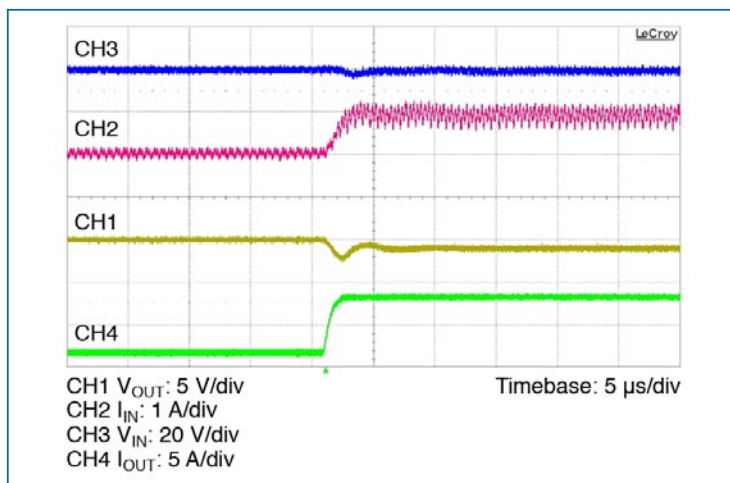


Figure 11 — Positive load transient (0 – 7.3 A)

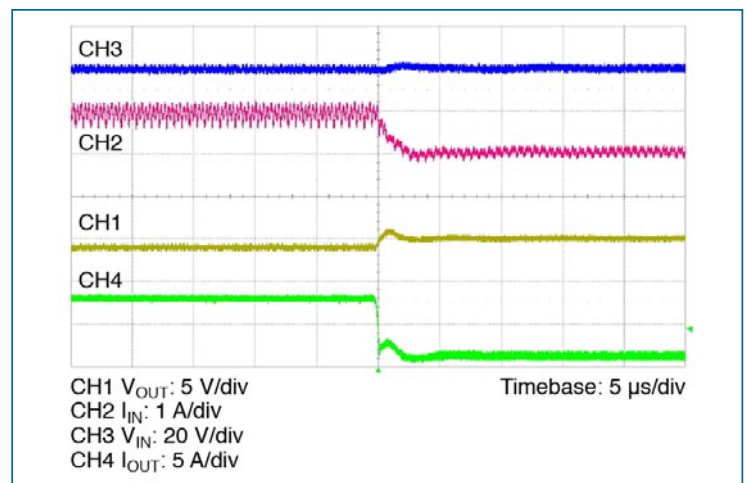


Figure 12 — Negative load transient (7.3 A – 0 A)

SPECIFICATIONS (CONT.)

WAVEFORMS (CONT.)

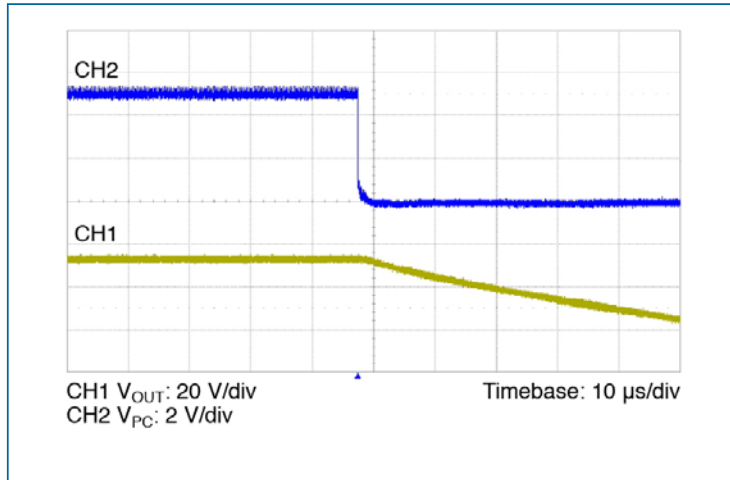


Figure 13 — PC disable waveform, 270 V_{IN} , 100 μ F C_{OUT} full load

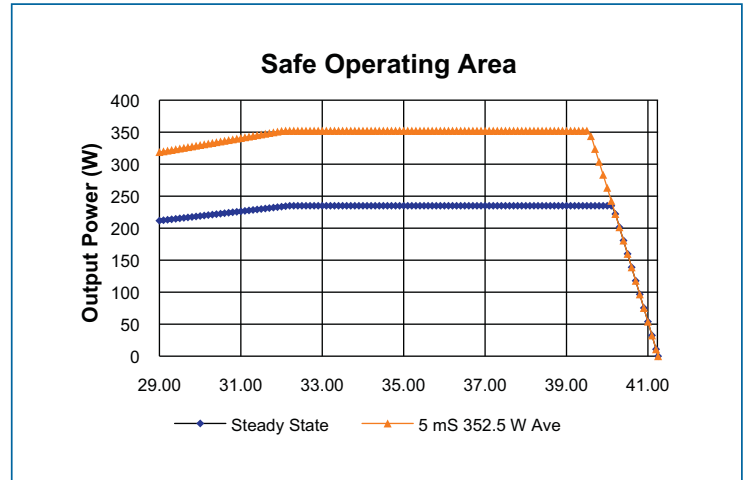


Figure 14 — Safe Operating Area vs. V_{OUT}

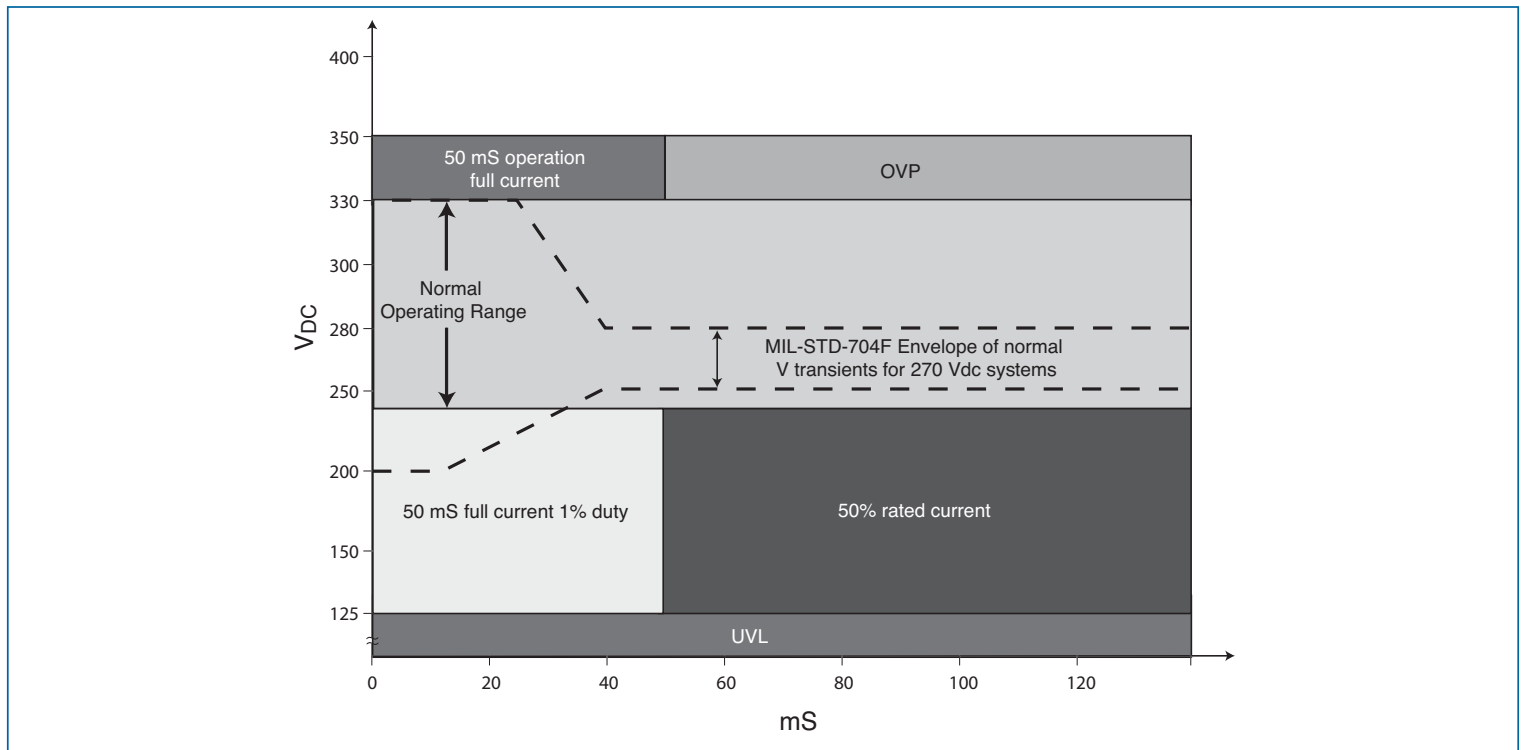


Figure 15 — Envelope of normal voltage transient for 270 volts DC system.

SPECIFICATIONS (CONT.)

All specifications are at $T_C = 25^\circ\text{C}$ unless otherwise noted. See associated figures for general trend data.

Package / Mechanical Specifications						
Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Length	L			48.6 / 1.91		mm/in
Width	W			27.7 / 1.09		mm/in
Height	H			9.5 / 0.37		mm/in
Weight	W			1.10/31.3		oz/g
Operating Temperature	T_C	Baseplate temperature	-40		100	$^\circ\text{C}$
Storage Temperature	T_{ST}		-65		125	$^\circ\text{C}$
Thermal Capacity				23.8		Ws/ $^\circ\text{C}$
Thermal Impedance	\varnothing_{BA}	Baseplate - Ambient		7.7		$^\circ\text{C}/\text{W}$
		Baseplate - Ambient 1000 LFM		2.9		$^\circ\text{C}/\text{W}$
	\varnothing_{BS}	Baseplate - Sink Greased		0.4		$^\circ\text{C}/\text{W}$
		Baseplate - Thermal Pad		0.36		$^\circ\text{C}/\text{W}$

Power, Voltage, Efficiency Relationships

Because of the high frequency, fully resonant SAC topology, power dissipation and overall conversion efficiency of BCM converters can be estimated as shown below.

Key relationships to be considered are the following:

1. Transfer Function

a. No load condition

$$V_{OUT} = V_{IN} \cdot K \quad \text{Eq. 1}$$

Where K (transformer turns ratio) is constant for each part number

b. Loaded condition

$$V_{OUT} = V_{IN} \cdot K - I_{OUT} \cdot R_{OUT} \quad \text{Eq. 2}$$

2. Dissipated Power

The two main terms of power losses in the BCM module are:

- No load power dissipation (P_{NL}) defined as the power used to power up the module with an enabled power train at no load.
- Resistive loss (R_{OUT}) refers to the power loss across the BCM modeled as pure resistive impedance.

$$P_{DISSIPATED} \approx P_{NL} + P_{R_{OUT}} \quad \text{Eq. 3}$$

Therefore, with reference to the diagram shown in Figure 16

$$P_{OUT} = P_{IN} - P_{DISSIPATED} = P_{IN} - P_{NL} - P_{R_{OUT}} \quad \text{Eq. 4}$$

Notice that R_{OUT} is temperature and input voltage dependent and P_{NL} is temperature dependent (See Figure 16).

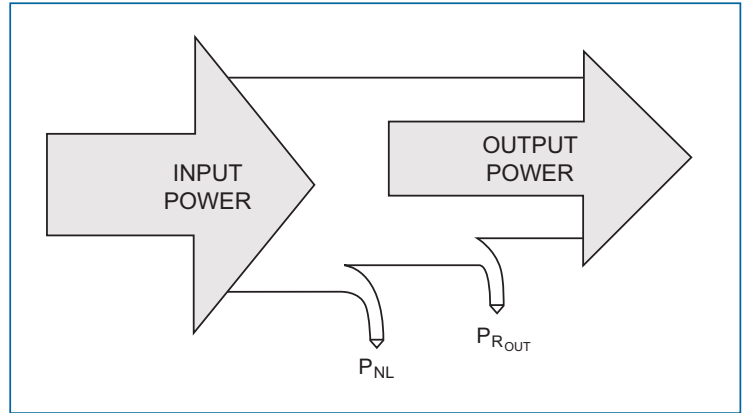


Figure 19 — Power transfer diagram

The above relations can be combined to calculate the overall module efficiency:

$$\eta = \frac{P_{OUT}}{P_{IN}} = \frac{P_{IN} - P_{NL} - P_{R_{OUT}}}{P_{IN}} = \frac{V_{IN} \cdot I_{IN} - P_{NL} - (I_{OUT})^2 \cdot R_{OUT}}{V_{IN} \cdot I_{IN}} = 1 - \left(\frac{P_{NL} + (I_{OUT})^2 \cdot R_{OUT}}{V_{IN} \cdot I_{IN}} \right) \quad \text{Eq. 5}$$

TIMING DIAGRAM

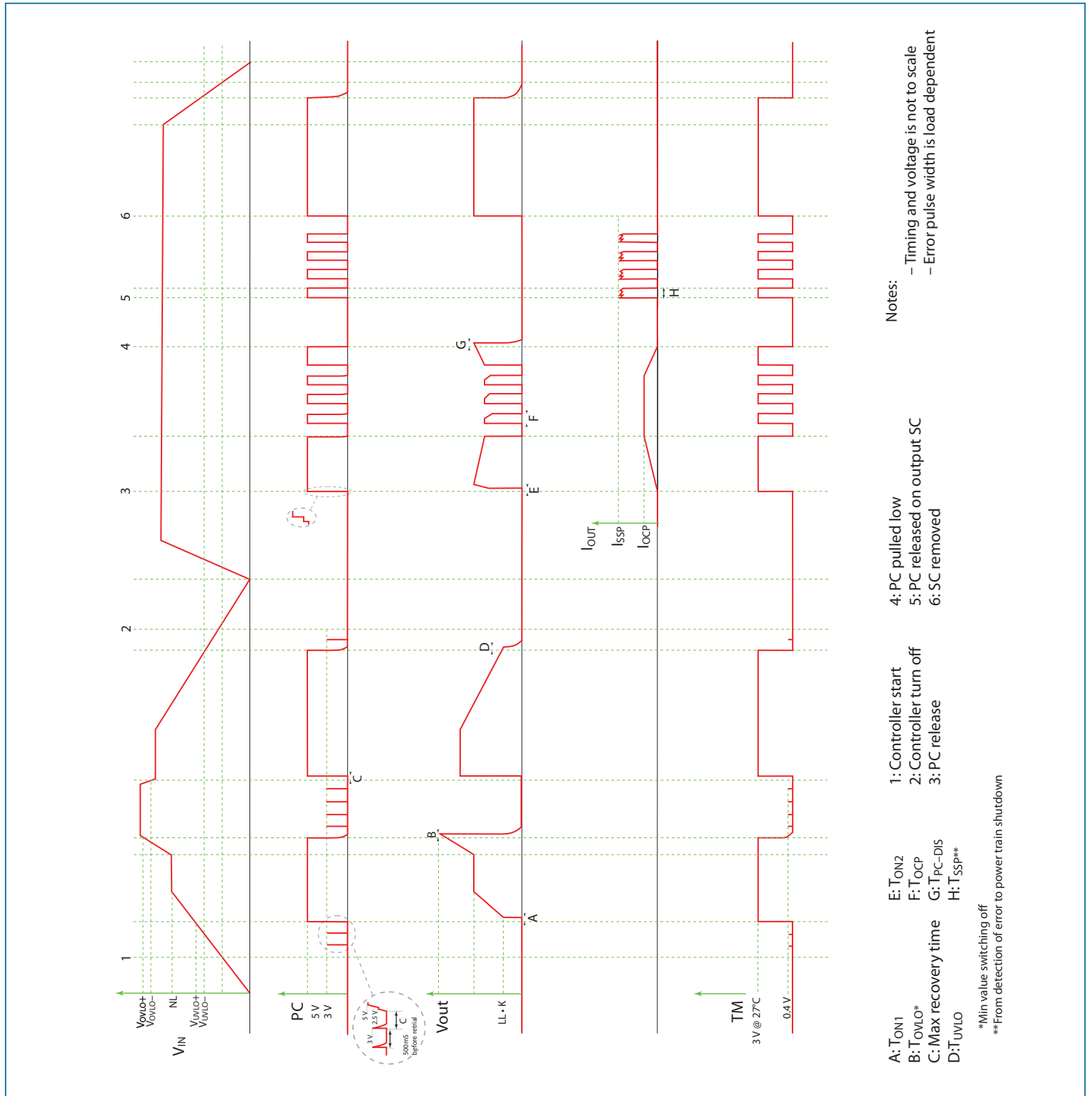


Figure 20 – Timing diagram

Using the Control Signals TM and PC

The PC control pin can be used to accomplish the following functions:

- **Delayed start:** At start-up, PC pin will source a constant 100 uA current to the internal RC network. Adding an external capacitor will allow further delay in reaching the 2.5 V threshold for module start.
- **Synchronized start up:** In a parallel module array, PC pins shall be connected in order to ensure synchronous start of all the units. While every controller has a calibrated 2.5 V reference on PC comparator, many factors might cause different timing in turning on the 100 uA current source on each module, i.e.:
 - Different V_{IN} slew rate
 - Statistical component value distributionBy connecting all PC pins, the charging transient will be shared and all the modules will be enabled synchronously.
- **Auxiliary voltage source:** Once enabled in regular operational conditions (no fault), each BCM PC provides a regulated 5 V, 2 mA voltage source.
- **Output Disable:** PC pin can be actively pulled down in order to disable module operations. Pull down impedance shall be lower than 850 Ω and toggle rate lower than 1 Hz.
- **Fault detection flag:** The PC 5 V voltage source is internally turned off as soon as a fault is detected. After a minimum disable time, the module tries to re-start, and PC voltage is re-enabled. For system monitoring purposes (microcontroller interface) faults are detected on falling edges of PC signal.

It is important to notice that PC doesn't have current sink capability (only 150 k Ω typical pull down is present), therefore, in an array, PC line will not be capable of disabling all the modules if a fault occurs on one of them.

The temperature monitor (TM) pin provides a voltage proportional to the absolute temperature of the converter control IC.

It can be used to accomplish the following functions:

- **Monitor the control IC temperature:** The temperature in Kelvin is equal to the voltage on the TM pin scaled by x100. (i.e. 3.0 V = 300 K = 27°C). It is important to remember that VI BRICKs are multi-chip modules, whose temperature distribution greatly vary for each part number as well with input/output conditions, thermal management and environmental conditions. Therefore, TM cannot be used to thermally protect the system.
- **Fault detection flag:** The TM voltage source is internally turned off as soon as a fault is detected. After a minimum disable time, the module tries to re-start, and TM voltage is re-enabled.

Fuse Selection

VI BRICKs are not internally fused in order to provide flexibility in configuring power systems. Input line fusing of VI BRICKs is recommended at system level, in order to provide thermal protection in case of catastrophic failure.

The fuse shall be selected by closely matching system requirements with the following characteristics:

- Current rating (usually greater than maximum BCM current)
- Maximum voltage rating (usually greater than the maximum possible input voltage)
- Ambient temperature
- Nominal melting I^2t
- Recommended fuse: ≤ 2.5 A Bussmann PC-Tron or SOC type 36CFA.

Current Sharing

The SAC topology bases its performance on efficient transfer of energy through a transformer, without the need of closed loop control. For this reason, the transfer characteristic can be approximated by an ideal transformer with some resistive drop and positive temperature coefficient.

This type of characteristic is close to the impedance characteristic of a DC power distribution system, both in behavior (AC dynamic) and absolute value (DC dynamic).

When connected in an array (with same K factor), the BCM module will inherently share the load current with parallel units, according to the equivalent impedance divider that the system implements from the power source to the point of load.

It is important to notice that, when successfully started, BCMs are capable of bidirectional operations (reverse power transfer is enabled if the BCM input falls within its operating range and the BCM is otherwise enabled). In parallel arrays, because of the resistive behavior, circulating currents are never experienced (energy conservation law).

General recommendations to achieve matched array impedances are (see also AN016 for further details):

- to dedicate common copper planes within the PCB to deliver and return the current to the modules
- to make the PCB layout as symmetric as possible
- to apply same input/output filters (if present) to each unit

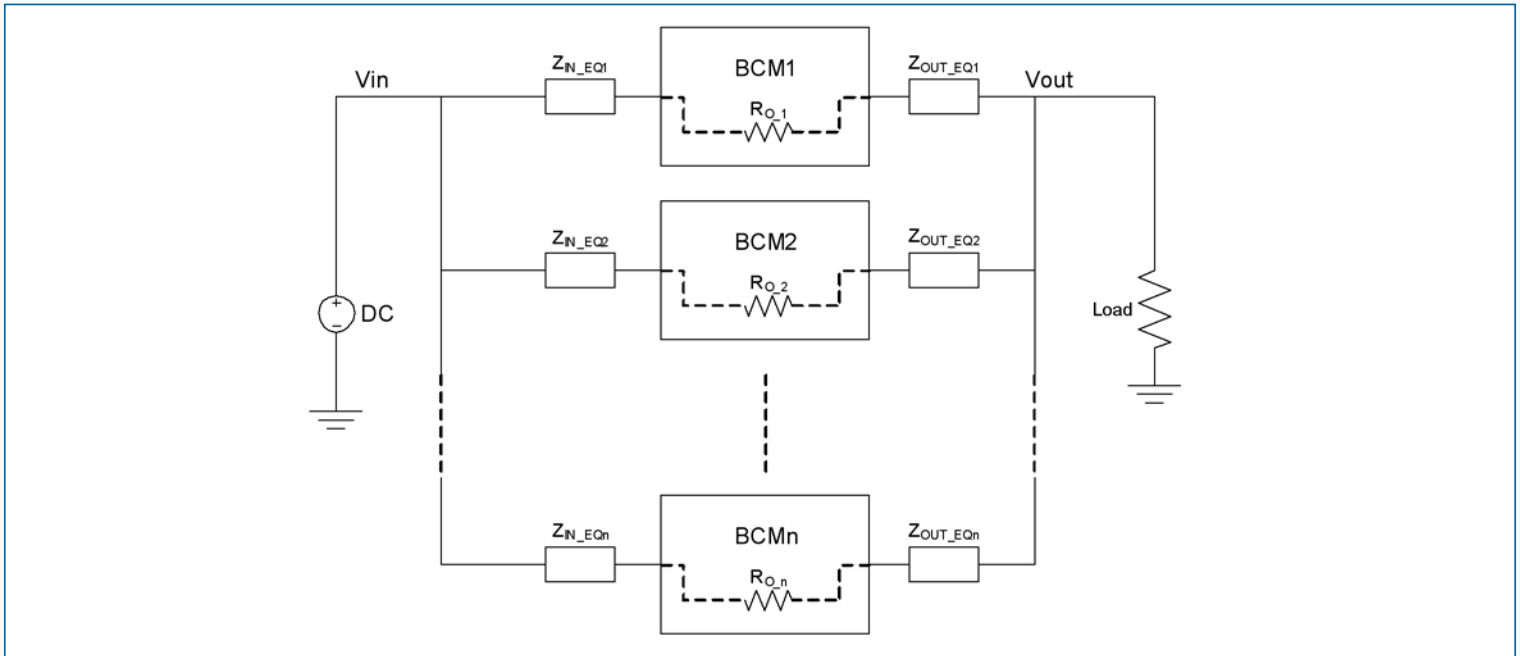


Figure 21 – BCM Array

Input and Output Filter Design

A major advantage of SAC systems versus conventional PWM converters is that the transformers do not require large functional filters. The resonant LC tank, operated at extreme high frequency, is amplitude modulated as a function of input voltage and output current, and efficiently transfers charge through the isolation transformer. A small amount of capacitance, embedded in the input and output stages of the module, is sufficient for full functionality and is key to achieve power density.

This paradigm shift requires system design to carefully evaluate external filters in order to:

1. Guarantee low source impedance:

To take full advantage of the BCM dynamic response, the impedance presented to its input terminals must be low from DC to approximately 5 MHz. The connection of the VI BRICK to its power source should be implemented with minimal distribution inductance. If the interconnect inductance exceeds 100 nH, the input should be bypassed with a RC damper to retain low source impedance and stable operation. With an interconnect inductance of 200 nH, the RC damper may be as high as 1 μ F in series with 0.3 Ω . A single electrolytic or equivalent low-Q capacitor may be used in place of the series RC bypass.

2. Further reduce input and/or output voltage ripple without sacrificing dynamic response:

Given the wide bandwidth of the BCM, the source response is generally the limiting factor in the overall system response. Anomalies in the response of the source will appear at the output of the BCM multiplied by its K factor. This is illustrated in Figures 11 and 12.

3. Protect the module from overvoltage transients imposed by the system that would exceed maximum ratings and cause failures:

The VI BRICK input/output voltage ranges shall not be exceeded. An internal overvoltage lockout function prevents operation outside of the normal operating input range. Even during this condition, the powertrain is exposed to the applied voltage and power MOSFETs must withstand it. A criterion for protection is the maximum amount of energy that the input or output switches can tolerate if avalanched.

Total load capacitance at the output of the BCM shall not exceed the specified maximum. Owing to the wide bandwidth and low output impedance of the BCM, low frequency bypass capacitance and significant energy storage may be more densely and efficiently provided by adding capacitance at the input of the BCM. At frequencies <500 kHz the BCM appears as an impedance of R_{OUT} between the source and load. Within this frequency range capacitance at the input appears as effective capacitance on the output per the relationship defined in Eq. 5.

$$C_{OUT} = \frac{C_{IN}}{K^2} \quad \text{Eq. 6}$$

This enables a reduction in the size and number of capacitors used in a typical system.

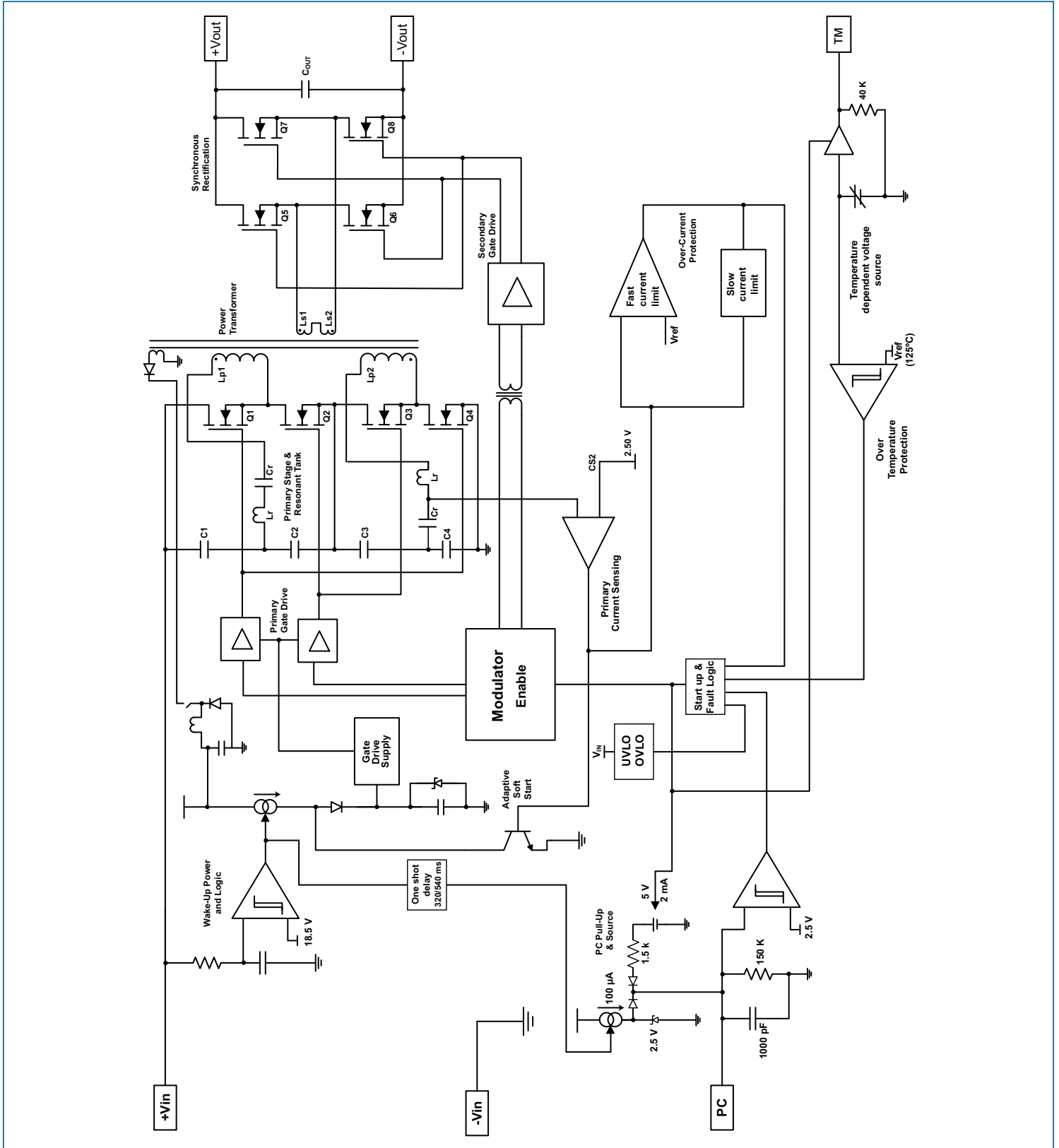


Figure 22 — BCM block diagram

Warranty

Vicor products are guaranteed for two years from date of shipment against defects in material or workmanship when in normal use and service. This warranty does not extend to products subjected to misuse, accident, or improper application or maintenance. Vicor shall not be liable for collateral or consequential damage. This warranty is extended to the original purchaser only.

EXCEPT FOR THE FOREGOING EXPRESS WARRANTY, VICOR MAKES NO WARRANTY, EXPRESS OR IMPLIED, INCLUDING, BUT NOT LIMITED TO, THE WARRANTY OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE.

Vicor will repair or replace defective products in accordance with its own best judgement. For service under this warranty, the buyer must contact Vicor to obtain a Return Material Authorization (RMA) number and shipping instructions. Products returned without prior authorization will be returned to the buyer. The buyer will pay all charges incurred in returning the product to the factory. Vicor will pay all reshipment charges if the product was defective within the terms of this warranty.

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Vicor's comprehensive line of power solutions includes high density AC-DC and DC-DC modules and accessory components, fully configurable AC-DC and DC-DC power supplies, and complete custom power systems.

Information furnished by Vicor is believed to be accurate and reliable. However, no responsibility is assumed by Vicor for its use. Vicor components are not designed to be used in applications, such as life support systems, wherein a failure or malfunction could result in injury or death. All sales are subject to Vicor's Terms and Conditions of Sale, which are available upon request.

Specifications are subject to change without notice.

Intellectual Property Notice

Vicor and its subsidiaries own Intellectual Property (including issued U.S. and Foreign Patents and pending patent applications) relating to the products described in this data sheet. Interested parties should contact Vicor's Intellectual Property Department.

The products described on this data sheet are protected by the following U.S. Patents Numbers: 5,945,130; 6,403,009; 6,710,257; 6,911,848; 6,930,893; 6,934,166; 6,940,013; 6,969,909; 7,038,917; 7,166,898; 7,187,263; 7,361,844; D496,906; D505,114; D506,438; D509,472; and for use under 6,975,098 and 6,984,965

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